

HI-P INTERNATIONAL LIMITED

(Company Registration No.: 198004817H)

(Incorporated in the Republic of Singapore)

INCREASE CREDIT FACILITIES FROM DBS BANK LTD

The Board of Directors of Hi-P International Limited (the “**Company**”) refers to the Company’s announcement of 22 August 2012 in relation to the acceptance of revised banking facilities of US\$80,000,000 and S\$1,100,000 (“**Facilities**”) from DBS Bank Ltd. (the “**Bank**”).

The Board of Directors of the Company wishes to announce that the Company and its wholly-owned subsidiaries, Hi-P Electronics Pte Ltd (“**Hi-P Electronics**”) and Hi-P (Singapore) Technology Pte Ltd (“**Hi-P (Singapore) Technology**”) have on 24 June 2015 accepted an offer from DBS Bank Ltd (the “**Bank**”) to revise its banking facilities to US\$130,000,000 and S\$1,100,000 (the “**Increased Facilities**”). The Increased Facilities comprise of overdraft facility, letters of credit, fixed advanced facility, short term loan, and letters of guarantee. The Increased Facilities are uncommitted and unsecured. The Bank has the right to review the Increased Facilities from time to time and to demand repayment of all outstanding Increased Facilities, actual or contingent. The Company, Hi-P Electronics, and Hi-P (Singapore) Technology are jointly and severally liable to the Bank for the outstanding Facilities.

The Company, Hi-P Electronics, and Hi-P (Singapore) Technology intend to apply the Increased Facilities for general working capital purposes.

The Increased Facilities are not expected to have any material effect on the net tangible assets per share and earnings per share of the Company and the Group for the current financial year ending 31 December 2015.

None of the Directors or substantial shareholders of the Company has any interest in the above transaction.

By Order of the Board of Directors

Yao Hsiao Tung
Executive Chairman and Chief Executive Director
24 June 2015